

**Supplementary Information for:**

**Stable Lithium Plating/Stripping Electrochemistry Promoted by MnO<sub>2</sub>  
Modified Copper Current Collector for Stable Lithium Metal Anodes**

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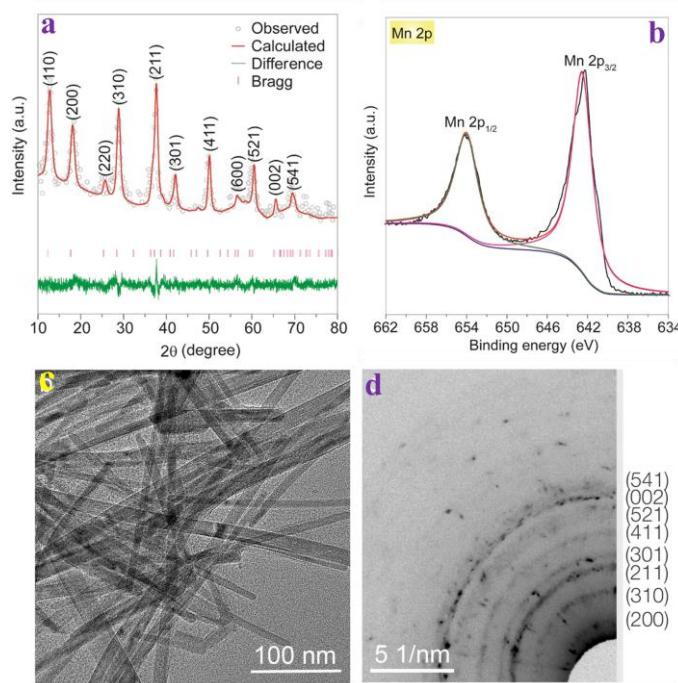
## Note S1. Characterizations

The produced sample's XRD was observed using Cu K $\alpha$  ( $\lambda = 1.5406$ ) radiation by D8 Advance Bruker. Rietveld refinement was performed in the FullProf program using the pseudo-Voigt work function. A ThermoElectron ESCALAB 250 spectrometer was also used to conduct the XPS examination, and Al K $\alpha$  radiation (1486.6 eV) was used. Using FEI TECNAI G2 20 Twin equipment, high resolution transmission electron microscopy (HRTEM) was used to analyze morphology and structural composition.

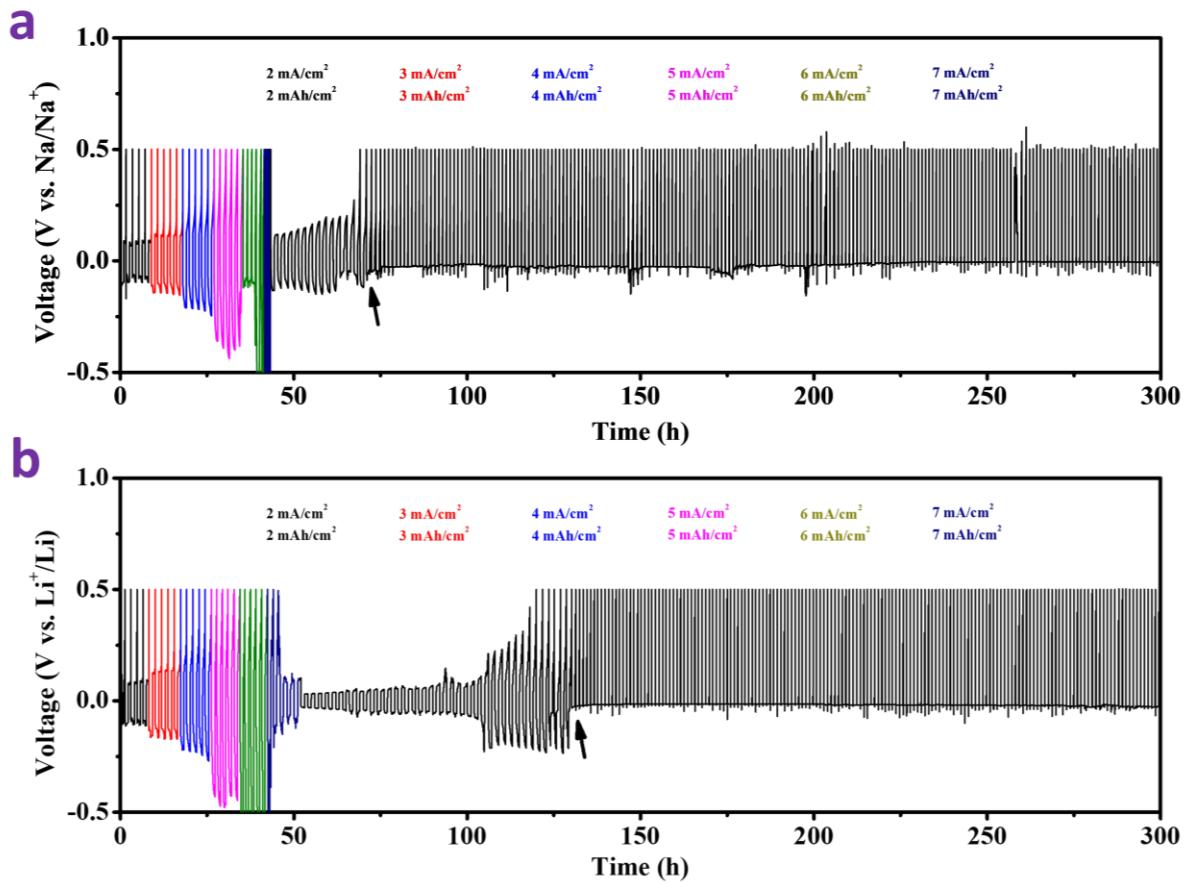
**Table S1** Comparison of electrochemical performances of modified copper current collectors.

Modification	Cell type	Nucleation overpotential (mV)		Ref.
		Before modification	After modification	
Dealloying method	Cu Li	79.3	42.6	<sup>1</sup>
Organic protective layer	Cu@ $\beta$ -PVDF Li	31–80	33	<sup>2</sup>
Oxidation method	Cu-CuO Li	200	25	<sup>3</sup>
Organic template method	Cu Li	60	28	<sup>4</sup>
Alloying method	Cu-Zn Li	>40	18	<sup>5</sup>
	Cu-Zn Li	~205	~75	<sup>6</sup>
Spot modification	Cu@ZnO Li	~168	~56.4	<sup>7</sup>
	Cu@Ag Li	67.9	47.1	<sup>8</sup>
Inorganic-organic protective layer	Cu@LLN Li	65–84	45–90	<sup>9</sup>
	Cu@NDC/ZnO Li	38	27	<sup>10</sup>
	Cu@LiF-Pan400 LFP	–	–	<sup>11</sup>
Inorganic protective layer	Cu@AlN <sub>3</sub>  LFP	~222	~146	<sup>12</sup>
	Cu@C LFP	~210	~50	<sup>13</sup>
	Cu@LTO/Zn/Zn@Li	~21	~16	<sup>14</sup>

	Cu@Cu <sub>3</sub> N LFP	—	—	15
	Cu@Li Li	~70	20	16
	Cu@ $\alpha$ -Si <sub>3</sub> N <sub>4</sub>  Li	—	—	17
	Cu@CNF Li	~77	~27	18
	Cu@Li <sub>2</sub> S Li	70.2	12.5	19
	Cu@g-C <sub>3</sub> N <sub>4</sub>  Li	92	~20	20
	Cu@GN Li	—	—	21
	Cu@Ag-A <sub>2</sub> O <sub>3</sub>  Li	100	~0	22
	Cu@AZO LFP	>500	110	23
	Cu@MnO <sub>2</sub>  Li	101	19	Our work



**Fig. S1.** (a) XRD spectrum, (b) XPS spectra deconvolution of core level spectra for Mn 2p, (c) HRTEM image, (d) SAED pattern of MnO<sub>2</sub> sample. [Reproduced from ref 24. Available under a CC-BY license. Copyright 2021, Bidhan Pandit et al./American Chemical Society.]



**Fig. S2.** Rate performance of lithium plating/stripping on (a) bare Cu and (b)  $\text{MnO}_2@\text{Cu}$  at the current density 2-7  $\text{mA/cm}^2$  and areal capacity 2-7  $\text{mAh/cm}^2$ .

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